

Participation Form

Technical Meeting on Local Stakeholder Engagement in Radioactive Waste Management

IAEA Headquarters Vienna, Austria: and virtual participation via Cisco Webex

16–20 October 2023

To be completed by the participant and sent to the competent national authority (e.g. Ministry of Foreign Affairs, Permanent Mission to the IAEA, or National Atomic Energy Authority) of his/her country for subsequent transmission to the International Atomic Energy Agency (IAEA) either by email to: Official.Mail@iaea.org or by fax to: +43 1 26007 (no hard copies needed). Please also send a copy by email to the Scientific Secretary S.Horiguchi@iaea.org and to the Administrative Secretary S.T.Elamkunnam@iaea.org.

Deadline for receipt by IAEA through official channels: 31 August 2023

Family name(s): (same as in passport)	First name(s): (same as in passport)	Mr/Ms
Institution:		
Full address:		
Tel. (Fax):		
Email:		
Nationality:	Representing following Member State/non-Member State/entity or invited organization:	
If/as applicable:		
Do you intend to submit a paper?	Yes <input type="checkbox"/>	No <input type="checkbox"/>
Would you prefer to present your paper as a poster?	Yes <input type="checkbox"/>	No <input type="checkbox"/>
Title:		
I plan to attend virtually:	Yes <input type="checkbox"/>	No <input type="checkbox"/>

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for registration] Further information can be found in the [Data Processing Notice](#) concerning IAEA InTouch+ platform.